

DOCKET NUMBER: 217636US3/rm



2814
RECEIVED #7
JUN 27 2002 T. BELL.
7:03:02
TECHNOLOGY CENTER 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF : Shigeo KOUZUKI, et al.
SERIAL NUMBER: 10/020,928 : GROUP: 2814
FILED: December 19, 2001 : EXAMINER:
FOR: SEMICONDUCTOR DEVICE AND PACKAGE THEREOF

LETTER


Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

On March 20, 2002, we filed an Information Disclosure Statement citing reference JP 2000-114445. Submitted herewith is the Statement of Relevancy of the same for Examiner's consideration.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.


C. Irvin McClelland
Attorney of Record
Registration Number: 21,124



22850

Tel. (703) 413-3000
Fax. (703) 413-2220
(OSMMN 10/98)

Paul A. Sacher
Registration No. 43,418

DOCKET NO: 217636US3

Sheet 1 of 1

SERIAL NO: 10/020,928

Group ~~Art~~ Unit: 2814

STATEMENT OF RELEVANCY

Reference JP 2000-114445:

This reference discloses a Cu strap which decreases resistance and inductance of a MOS device. A semiconductor package which has a copper plate coupled to a major part of source metal, and a beam part. Indurative conductive material is sandwiched between the copper plate and source metal.